



NTE2395
MOSFET
N-Ch, Enhancement Mode
High Speed Switch

Features:

- Dynamic dv/dt Rating
- +175°C Operating Temperature
- Fast Switching
- Ease of Parallelizing
- Simple Drive Requirements

Absolute Maximum Ratings:

Continuous Drain Current ($V_{GS} = 10V$), I_D

$T_C = +25^\circ C$ (Note 1) 50A
 $T_C = +100^\circ C$ 36A

Pulsed Drain Current (Note 2), I_{DM} 200A

Power Dissipation ($T_C = +25^\circ C$), P_D 150W
 Derate Linearly Above $25^\circ C$ $1.0W/^\circ C$

Gate-to-Source Voltage, V_{GS} $\pm 20V$

Single Pulse Avalanche Energy (Note 3), E_{AS} 100mJ

Peak Diode Recovery dv/dt (Note 4), dv/dt 4.5V/ns

Operating Junction Temperature Range, T_J -55° to $+175^\circ C$

Storage Temperature Range, T_{stg} -55° to $+175^\circ C$

Lead Temperature (During Soldering, 1.6mm from case for 10sec), T_L $+300^\circ C$

Mounting Torque (6-32 or M3 Screw) 10 lbf•in (1.1N•m)

Thermal Resistance, Junction-to-Case, R_{thJC} $1.0^\circ C/W$

Thermal Resistance, Junction-to-Ambient, R_{thJA} $62^\circ C/W$

Typical Thermal Resistance, Case-to-Sink (Flat, Greased Surface), R_{thCS} $0.5^\circ C/W$

Note 1. Current limited by the package, (Die Current = 51A).

Note 2. Repetitive rating; pulse width limited by maximum junction temperature.

Note 3. $V_{DD} = 25V$, starting $T_J = +25^\circ C$, $L = 44\mu H$, $R_G = 25\Omega$, $I_{AS} = 51A$

Note 4. $I_{SD} \leq 51A$, $di/dt \leq 250A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $T_J \leq +175^\circ C$

Electrical Characteristics: ($T_J = +25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-to-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}$, $I_D = 250\mu\text{A}$	60	—	—	V
Breakdown Voltage Temp. Coefficient	$\frac{\Delta V_{(\text{BR})\text{DSS}}}{\Delta T_J}$	Reference to $+25^\circ\text{C}$, $I_D = 1\text{mA}$	—	0.060	—	$\text{V}/^\circ\text{C}$
Static Drain-to-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}$, $I_D = 31\text{A}$, Note 5	—	—	0.028	Ω
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 250\mu\text{A}$	2.0	—	4.0	V
Forward Transconductance	g_{fs}	$V_{\text{DS}} = 25\text{V}$, $I_D = 31\text{A}$, Note 5	15	—	—	mhos
Drain-to-Source Leakage Current	I_{DSS}	$V_{\text{DS}} = 60\text{V}$, $V_{\text{GS}} = 0\text{V}$	—	—	25	μA
		$V_{\text{DS}} = 48\text{V}$, $V_{\text{GS}} = 0\text{V}$, $T_J = +125^\circ\text{C}$	—	—	250	μA
Gate-to-Source Forward Leakage	I_{GSS}	$V_{\text{GS}} = 20\text{V}$	—	—	100	nA
Gate-to-Source Reverse Leakage	I_{GSS}	$V_{\text{GS}} = -20\text{V}$	—	—	-100	nA
Total Gate Charge	Q_g	$I_D = 51\text{A}$, $V_{\text{DS}} = 48\text{V}$, $V_{\text{GS}} = 10\text{V}$, Note 5	—	—	67	nC
Gate-to-Source Charge	Q_{gs}		—	—	18	nC
Gate-to-Drain ("Miller") Charge	Q_{gd}		—	—	25	nC
Turn-On Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 30\text{V}$, $I_D = 51\text{A}$, $R_G = 9.1\Omega$, $R_D = 0.55\Omega$, Note 5	—	14	—	ns
Rise Time	t_r		—	110	—	ns
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		—	45	—	ns
Fall Time	t_f		—	92	—	ns
Internal Drain Inductance	L_D	Between lead, .250in. (6.0) mm from package and center of die contact	—	4.5	—	nH
Internal Source Inductance	L_S		—	7.5	—	nH
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}$, $V_{\text{DS}} = 25\text{V}$, $f = 1\text{MHz}$	—	1900	—	pF
Output Capacitance	C_{oss}		—	920	—	pF
Reverse Transfer Capacitance	C_{rss}		—	170	—	pF

Source-Drain Ratings and Characteristics:

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Continuous Source Current (Body Diode)	I_S	Note 1	—	—	50	A
Pulsed Source Current (Body Diode)	I_{SM}	Note 2	—	—	200	A
Diode Forward Voltage	V_{SD}	$T_J = +25^\circ\text{C}$, $I_S = 51\text{A}$, $V_{\text{GS}} = 0\text{V}$, Note 5	—	—	2.5	V
Reverse Recovery Time	t_{rr}	$T_J = +25^\circ\text{C}$, $I_F = 51\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$, Note 5	—	120	180	ns
Reverse Recovery Charge	Q_{rr}		—	0.53	0.80	μC
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S+L_D)				

Note 1. Current limited by the package, (Die Current = 51A).

Note 2. Repetitive rating; pulse width limited by maximum junction temperature.

Note 5. Pulse width $\leq 300\mu\text{s}$; duty cycle $\leq 2\%$.

